



Support & training



SN54HC541, SN74HC541 SCLS305E – JANUARY 1996 – REVISED MAY 2022

## SNx4HC541 Octal Buffers and Line Drivers With 3-State Outputs

### 1 Features

- Wide Operating Voltage Range of 2 V to 6 V
- High-Current 3-State Outputs Drive Bus Lines
   Directly or Up to 15 LSTTL Loads
- Low Power Consumption, 80- $\mu$ A Maximum I<sub>CC</sub>
- Typical t<sub>pd</sub> = 10 ns
- ±6-mA Output Drive at 5 V
- Low Input Current of 1 µA Maximum
- Data Flow-Through Pinout (All Inputs on Opposite Side From Outputs)

### 2 Applications

- LEDs
- Servers
- PCs and Notebooks
- Wearable Health and Wellness Devices
- Electronic Points of Sale

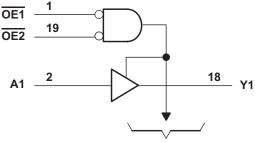
### **3 Description**

These octal buffers and line drivers feature the performance of the SNx4HC541 devices and a pinout with inputs and outputs on opposite sides of the package. This arrangement greatly facilitates printed circuit board layout.

The 3-state outputs are controlled by a two-input NOR gate. If either output-enable ( $\overline{OE1}$  or  $\overline{OE2}$ ) input is high, all eight outputs are in the high-impedance state. The SNx4HC541 devices provide true data at the outputs.

| Device Information |                        |                    |  |  |  |  |  |
|--------------------|------------------------|--------------------|--|--|--|--|--|
| PART NUMBER        | PACKAGE <sup>(1)</sup> | BODY SIZE (NOM)    |  |  |  |  |  |
| SN74HC541DW        | SOIC (20)              | 12.80 mm × 7.50 mm |  |  |  |  |  |
| SN74HC541DB        | SSOP (20)              | 7.20 mm × 5.30 mm  |  |  |  |  |  |
| SN74HC541N         | PDIP (20)              | 24.33 mm × 6.35 mm |  |  |  |  |  |
| SN74HC541NS        | SO (20)                | 12.60 mm × 5.30 mm |  |  |  |  |  |
| SN74HC541PW        | TSSOP (20)             | 6.50 mm × 4.40 mm  |  |  |  |  |  |
| SN54HC541J         | CDIP (20)              | 24.20 mm × 6.92 mm |  |  |  |  |  |
| SN54HC541FK        | LCCC (20)              | 8.89 mm × 8.89 mm  |  |  |  |  |  |

(1) For all available packages, see the orderable addendum at the end of the data sheet.



To Seven Other Channels

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**Functional Block Diagram** 



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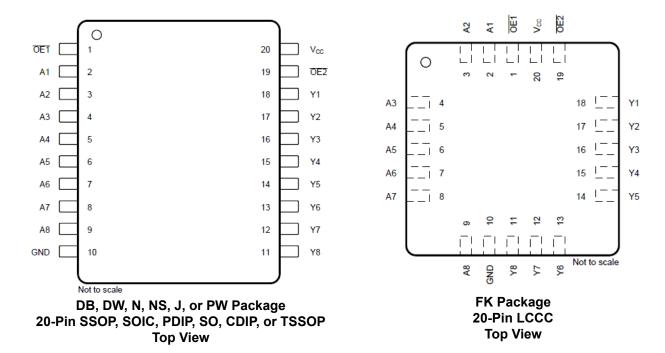
## **4 Revision History**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| CI | hanges from Revision D (September 2016) to Revision E (May 2022)   | Page            |
|----|--|-----------------|
| •  | Updated ESD ratings table to include modern TI terminology   | 4               |
| •  | Junction-to-ambient thermal resistance values increased. DB was 90.2 is now 122.7, DW was 77.5 is in   | now             |
|    | 109.1, N was 45.2 is now 84.6, NS was 72.8 is now 113.4, PW was 98.3 is now 131.8  | 5               |
| CI | hanges from Revision C (August 2003) to Revision D (September 2016)  | Page            |
| •  | Added Applications section, Thermal Information table, ESD Ratings table, Feature Description section<br>Device Functional Modes, Application and Implementation section, Power Supply Recommendations s<br>Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderat<br>Information section. | section,<br>ble |
| •  | Deleted Ordering Information table, see Mechanical, Packaging, and Orderable Information at the end datasheet  |                 |
| •  | Changed R <sub>0JA</sub> for DB package from 70°C/W: to 90.2°C/W   | 5               |
| •  | Changed R <sub>0JA</sub> for DW package from 58°C/W: to 77.5°C/W   |                 |
| •  | Changed R <sub>0JA</sub> for N package from 69°C/W: to 45.2°C/W  | 5               |
| •  | Changed R <sub>0JA</sub> for NS package from 60°C/W: to 72.8°C/W   | <mark>5</mark>  |
| •  | Changed R <sub>0JA</sub> for PW package from 83°C/W: to 98.3°C/W   |                 |



## **5** Pin Configuration and Functions



#### **Pin Functions**

| PIN |                 | I/O <sup>(1)</sup> | DESCRIPTION  |
|-----|-----------------|--------------------|--|
| NO. | NAME            | 1/0                | DESCRIPTION  |
| 1   | OE1             | I                  | Output enable (active low) Both OE must be low to enable outputs |
| 2   | A1              | I                  | Channel 1 input  |
| 3   | A2              | I                  | Channel 2 input  |
| 4   | A3              | I                  | Channel 3 input  |
| 5   | A4              | I                  | Channel 4 input  |
| 6   | A5              | I                  | Channel 5 input  |
| 7   | A6              | I                  | Channel 6 input  |
| 8   | A7              | I                  | Channel 7 input  |
| 9   | A8              | I                  | Channel 8 input  |
| 10  | GND             | _                  | Ground   |
| 11  | Y8              | 0                  | Channel 8 output   |
| 12  | Y7              | 0                  | Channel 7 output   |
| 13  | Y6              | 0                  | Channel 6 output   |
| 14  | Y5              | 0                  | Channel 5 output   |
| 15  | Y4              | 0                  | Channel 4 output   |
| 16  | Y3              | 0                  | Channel 3 output   |
| 17  | Y2              | 0                  | Channel 2 output   |
| 18  | Y1              | 0                  | Channel 1 output   |
| 19  | OE2             | I                  | Output enable (active low) both OE must be low to enable outputs |
| 20  | V <sub>CC</sub> | _                  | Power pin  |

(1) Signal Types: I = Input, O = Output, I/O = Input or Output.



### 6 Specifications

#### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                  |   |   | MIN  | MAX | UNIT |
|------------------|---|---|------|-----|------|
| V <sub>CC</sub>  | Supply voltage                                    |   | -0.5 | 7   | V    |
| I <sub>IK</sub>  | Input clamp current <sup>(2)</sup>                | $V_{I} < 0 \text{ or } V_{I} > V_{CC}$        |      | ±20 | mA   |
| I <sub>OK</sub>  | Output clamp current <sup>(2)</sup>               | $V_{\rm O}$ < 0 or $V_{\rm O}$ > $V_{\rm CC}$ |      | ±20 | mA   |
| lo               | Continuous output current                         | $V_{O} = 0$ to $V_{CC}$                       |      | ±35 | mA   |
|                  | Continuous current through V <sub>CC</sub> or GND |   |      | ±70 | mA   |
| T <sub>stg</sub> | Storage temperature                               |   | -65  | 150 | °C   |

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

### 6.2 ESD Ratings

|  |   |                         |   | VALUE | UNIT |
|--|---|-------------------------|---|-------|------|
|  | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup> | ±2000                   | V   |       |      |
|  | V <sub>(ESD)</sub>  | Electrostatic discharge | Charged device model (CDM), per ANSI/ESDA/JEDEC JS-002 <sup>(2)</sup> | ±1000 | V    |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

#### 6.3 Recommended Operating Conditions

#### See note<sup>(1)</sup>

|                 |                                     |                         | MIN  | NOM | MAX             | UNIT |
|-----------------|-------------------------------------|-------------------------|------|-----|-----------------|------|
| V <sub>CC</sub> | Supply voltage                      |                         | 2    | 5   | 6               | V    |
|                 |                                     | V <sub>CC</sub> = 2 V   | 1.5  |     |                 |      |
| V <sub>IH</sub> | High-level input voltage            | V <sub>CC</sub> = 4.5 V | 3.15 |     |                 | V    |
|                 |                                     | V <sub>CC</sub> = 6 V   | 4.2  |     |                 |      |
| V <sub>IL</sub> |                                     | V <sub>CC</sub> = 2 V   |      |     | 0.5             |      |
|                 | Low-level input voltage             | V <sub>CC</sub> = 4.5 V |      |     | 1.35            | V    |
|                 |                                     | V <sub>CC</sub> = 6 V   |      |     | 1.8             |      |
| VI              | Input voltage                       |                         | 0    |     | V <sub>CC</sub> | V    |
| Vo              | Output voltage                      |                         | 0    |     | V <sub>CC</sub> | V    |
|                 |                                     | V <sub>CC</sub> = 2 V   |      |     | 1000            |      |
| Δt/Δv           | Input transition rise and fall time | V <sub>CC</sub> = 4.5 V |      |     | 500             | ns   |
|                 |                                     | V <sub>CC</sub> = 6 V   |      |     | 400             |      |
| т               | Operating free-air temperature      | SN54HC541               | -55  |     | 125             | °C   |
| Τ <sub>Α</sub>  |                                     | SN74HC541               | -40  |     | 85              | U    |

 All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. See *Implications of Slow or Floating* CMOS Inputs, SCBA004.



### 6.4 Thermal Information

|                        |   | SN74HC541 |           |          |         |            |      |  |
|------------------------|---|-----------|-----------|----------|---------|------------|------|--|
|                        |   | DB (SSOP) | DW (SOIC) | N (PDIP) | NS (SO) | PW (TSSOP) |      |  |
| THERMAL                | METRIC  | 20 PINS   | 20 PINS   | 20 PINS  | 20 PINS | 20 PINS    | UNIT |  |
| R <sub>θJA</sub>       | Junction-to-ambient thermal resistance <sup>(1)</sup> | 122.7     | 109.1     | 84.6     | 113.4   | 131.8      | °C/W |  |
| R <sub>θJC (top)</sub> | Junction-to-case (top) thermal resistance             | 81.6      | 76        | 72.5     | 78.6    | 72.2       | °C/W |  |
| $R_{\theta JB}$        | Junction-to-board thermal resistance                  | 77.5      | 77.6      | 65.3     | 78.4    | 82.8       | °C/W |  |
| $\Psi_{JT}$            | Junction-to-top characterization parameter            | 46.1      | 51.5      | 55.3     | 47.1    | 21.5       | °C/W |  |
| $\Psi_{JB}$            | Junction-to-board characterization parameter          | 77.1      | 77.1      | 65.2     | 78.1    | 82.4       | °C/W |  |
| $R_{\theta JC(bot)}$   | Junction-to-case (bottom) thermal resistance          | N/A       | N/A       | N/A      | N/A     | N/A        | °C/W |  |

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

## 6.5 Electrical Characteristics, T<sub>A</sub> = 25°C

over operating free-air temperature range (unless otherwise noted)

| PARAMETER       | TEST  | CONDITIONS                | V <sub>cc</sub> | MIN   | TYP   | MAX  | UNIT |
|-----------------|---|---------------------------|-----------------|-------|-------|------|------|
|                 |   |                           | 2 V             | 1.9   | 1.998 |      |      |
|                 |   | I <sub>OH</sub> = –20 μA  | 4.5 V           | 4.4   | 4.499 |      |      |
| V <sub>OH</sub> | $V_{I} = V_{IH} \text{ or } V_{IL}$                 |                           | 6 V             | 5.9   | 5.999 |      | V    |
|                 |   | I <sub>OH</sub> = –6 mA   | 4.5 V           | 3.98  | 4.3   |      |      |
|                 |   | I <sub>OH</sub> = -7.8 mA | 6 V             | 5.48  | 5.8   |      |      |
|                 | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> |                           | 2 V             | 0.002 |       | 0.1  |      |
|                 |   | Ι <sub>ΟL</sub> = 20 μΑ   | 4.5 V           | 0.001 |       | 0.1  |      |
| V <sub>OL</sub> |   |                           | 6 V             | 0.001 |       | 0.1  | V    |
|                 |   | I <sub>OL</sub> = 6 mA    | 4.5 V           | 0.17  |       | 0.26 |      |
|                 |   | I <sub>OL</sub> = 7.8 mA  | 6 V             | 0.15  |       | 0.26 |      |
| l <sub>l</sub>  | $V_{I} = V_{CC} \text{ or } 0$                      |                           | 6 V             | ±0.1  |       | ±100 | nA   |
| I <sub>OZ</sub> | $V_{O} = V_{CC} \text{ or } 0$                      |                           | 6 V             | ±0.01 |       | ±0.5 | μA   |
| I <sub>CC</sub> | $V_{I} = V_{CC} \text{ or } 0, I_{O} = 0$           |                           | 6 V             |       |       | 8    | μA   |
| C <sub>i</sub>  |   |                           | 2 V to 6 V      |       | 3     | 10   | pF   |

### 6.6 Electrical Characteristics, SN54HC541

over operating free-air temperature range (unless otherwise noted)

| PARAMETER       | TEST CONDITIONS                     |                           | V <sub>cc</sub> | MIN | TYP | MAX | UNIT |
|-----------------|-------------------------------------|---------------------------|-----------------|-----|-----|-----|------|
| V <sub>OH</sub> | $V_{I} = V_{IH} \text{ or } V_{IL}$ | I <sub>OH</sub> = -20 μΑ  | 2 V             | 1.9 |     |     |      |
|                 |                                     |                           | 4.5 V           | 4.4 |     |     |      |
|                 |                                     |                           | 6 V             | 5.9 |     |     | V    |
|                 |                                     | I <sub>OH</sub> = –6 mA   | 4.5 V           | 3.7 |     |     |      |
|                 |                                     | I <sub>OH</sub> = -7.8 mA | 6 V             | 5.2 |     |     |      |

#### over operating free-air temperature range (unless otherwise noted)

| PARAMETER       | TEST CON                                  | IDITIONS                 | V <sub>cc</sub> | MIN | TYP | MAX   | UNIT |
|-----------------|---|--------------------------|-----------------|-----|-----|-------|------|
| V <sub>OL</sub> |   |                          | 2 V             |     |     | 0.1   |      |
|                 |   | I <sub>OL</sub> = 20 μA  | 4.5 V           |     |     | 0.1   |      |
|                 |   |                          | 6 V             |     |     | 0.1   | V    |
|                 |   | I <sub>OL</sub> = 6 mA   | 4.5 V           |     |     | 0.4   |      |
|                 |   | I <sub>OL</sub> = 7.8 mA | 6 V             |     |     | 0.4   |      |
| I <sub>I</sub>  | $V_{I} = V_{CC} \text{ or } 0$            |                          | 6 V             |     |     | ±1000 | nA   |
| I <sub>OZ</sub> | $V_0 = V_{CC} \text{ or } 0$              |                          | 6 V             |     |     | ±10   | μA   |
| I <sub>CC</sub> | $V_{I} = V_{CC} \text{ or } 0, I_{O} = 0$ |                          | 6 V             |     |     | 160   | μA   |
| Ci              |   |                          | 2 V to 6 V      |     |     | 10    | pF   |

#### 6.7 Electrical Characteristics, SN74HC541

over operating free-air temperature range (unless otherwise noted)

| PARAMETER       | TEST                                      | CONDITIONS                | V <sub>cc</sub> | MIN  | ТҮР | MAX   | UNIT |
|-----------------|---|---------------------------|-----------------|------|-----|-------|------|
|                 |   |                           | 2 V             | 1.9  |     |       | v    |
|                 |   | I <sub>OH</sub> = –20 μA  | 4.5 V           | 4.4  |     |       |      |
| V <sub>OH</sub> | $V_{I} = V_{IH} \text{ or } V_{IL}$       |                           | 6 V             | 5.9  |     |       | V    |
|                 |   | I <sub>OH</sub> = -6 mA   | 4.5 V           | 3.84 |     |       |      |
|                 |   | I <sub>OH</sub> = -7.8 mA | 6 V             | 5.34 |     |       |      |
|                 |   |                           | 2 V             |      |     | 0.1   | _    |
|                 |   | I <sub>OL</sub> = 20 μA   | 4.5 V           |      |     | 0.1   |      |
| V <sub>OL</sub> | $V_{I} = V_{IH} \text{ or } V_{IL}$       |                           | 6 V             |      |     | 0.1   | V    |
|                 |   | I <sub>OL</sub> = 6 mA    | 4.5 V           |      |     | 0.33  |      |
|                 |   | I <sub>OL</sub> = 7.8 mA  | 6 V             |      |     | 0.33  |      |
| l <sub>l</sub>  | $V_{I} = V_{CC} \text{ or } 0$            |                           | 6 V             |      |     | ±1000 | nA   |
| I <sub>OZ</sub> | $V_{O} = V_{CC} \text{ or } 0$            |                           | 6 V             |      |     | ±5    | μA   |
| I <sub>CC</sub> | $V_{I} = V_{CC} \text{ or } 0, I_{O} = 0$ |                           | 6 V             |      |     | 80    | μA   |
| C <sub>i</sub>  |   |                           | 2 V to 6 V      |      |     | 10    | pF   |

## 6.8 Switching Characteristics, $C_L$ = 50 pF, $T_A$ = 25°C

over recommended operating free-air temperature range, C<sub>L</sub> = 50 pF (unless otherwise noted) (see Figure 7-1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>cc</sub> | MIN TYP | MAX | UNIT |
|------------------|-----------------|----------------|-----------------|---------|-----|------|
|                  |                 |                | 2 V             | 40      | 115 |      |
| t <sub>pd</sub>  | А               | Y              | 4.5 V           | 12      | 23  | ns   |
|                  |                 |                | 6 V             | 10      | 20  |      |
|                  |                 |                | 2 V             | 80      | 150 |      |
| t <sub>en</sub>  | ŌĒ              | Y              | 4.5 V           | 17      | 30  | ns   |
|                  |                 |                | 6 V             | 15      | 26  |      |
|                  |                 |                | 2 V             | 40      | 150 |      |
| t <sub>dis</sub> | ŌĒ              | Y              | 4.5 V           | 18      | 30  | ns   |
|                  |                 |                | 6 V             | 17      | 26  |      |
|                  |                 |                | 2 V             | 28      | 60  |      |
| t <sub>t</sub>   |                 | Y              | 4.5 V           | 8       | 12  | ns   |
|                  |                 |                | 6 V             | 6       | 10  |      |



## 6.9 Switching Characteristics, $C_L$ = 50 pF, SN54HC541

| over recommended o | perating free-air tem | perature range C            | = 50  pE (unles | s otherwise noted)  | (see Figure 7-1) |
|--------------------|-----------------------|-----------------------------|-----------------|---------------------|------------------|
|                    | peraling nee-all ten  | iperature range, o <u>r</u> |                 | 3 00101 WI3C 110100 | (See Figure 7-1) |

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>cc</sub> | MIN TYP | МАХ | UNIT |
|------------------|-----------------|----------------|-----------------|---------|-----|------|
|                  |                 |                | 2 V             |         | 171 |      |
| t <sub>pd</sub>  | A               | Y              | 4.5 V           |         | 34  | ns   |
|                  |                 |                | 6 V             |         | 29  | ns   |
| t <sub>en</sub>  |                 |                | 2 V             |         | 224 |      |
|                  | ŌĒ              | Y              | 4.5 V           |         | 45  | ns   |
|                  |                 |                | 6 V             |         | 38  |      |
|                  |                 |                | 2 V             |         | 224 | ns   |
| t <sub>dis</sub> | ŌĒ              | Y              | 4.5 V           |         | 45  |      |
|                  |                 |                | 6 V             |         | 38  |      |
|                  |                 |                | 2 V             |         | 90  |      |
| t <sub>t</sub>   |                 | Y              | 4.5 V           |         | 18  | ns   |
|                  |                 |                | 6 V             |         | 15  |      |

## 6.10 Switching Characteristics, $C_L$ = 50 pF, SN74HC541

over recommended operating free-air temperature range,  $C_L = 50 \text{ pF}$  (unless otherwise noted) (see Figure 7-1)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>cc</sub> | MIN TYP MAX | UNIT |
|------------------|-----------------|----------------|-----------------|-------------|------|
|                  |                 |                | 2 V             | 144         |      |
| t <sub>pd</sub>  | А               | Y              | 4.5 V           | 29          | ns   |
|                  |                 |                | 6 V             | 25          |      |
|                  |                 |                | 2 V             | 188         |      |
| t <sub>en</sub>  | ŌĒ              | Y              | 4.5 V           | 38          | ns   |
|                  |                 |                | 6 V             | 32          | ns   |
|                  |                 |                | 2 V             | 188         |      |
| t <sub>dis</sub> | ŌĒ              | Y              | 4.5 V           | 38          | ns   |
|                  |                 |                | 6 V             | 32          |      |
|                  |                 |                | 2 V             | 75          |      |
| tt               |                 | Y              | 4.5 V           | 15          | ns   |
|                  |                 |                | 6 V             | 13          |      |

## 6.11 Switching Characteristics, $C_L$ = 150 pF, $T_A$ = 25°C

over recommended operating free-air temperature range,  $C_L = 150 \text{ pF}$  (unless otherwise noted) (see Figure 7-1)

| PARAMETER       | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>cc</sub> | MIN TYP | MAX | UNIT      |
|-----------------|-----------------|----------------|-----------------|---------|-----|-----------|
|                 |                 |                | 2 V             | 65      | 165 |           |
| t <sub>pd</sub> | А               | Y              | 4.5 V           | 16      | 33  | ns        |
|                 |                 |                | 6 V             | 14      | 28  |           |
|                 |                 |                | 2 V             | 100     | 200 | )<br>) ns |
| t <sub>en</sub> | ŌĒ              | Y              | 4.5 V           | 20      | 40  |           |
|                 |                 |                | 6 V             | 17      | 34  |           |
|                 |                 |                | 2 V             | 45      | 210 |           |
| tt              |                 | Y              | 4.5 V           | 17      | 42  | ns        |
|                 |                 |                | 6 V             | 13      | 36  |           |

## 6.12 Switching Characteristics, C<sub>L</sub> = 150 pF, SN54HC541

over recommended operating free-air temperature range, C<sub>L</sub> = 150 pF (unless otherwise noted) (see Figure 7-1)

| PARAMETER       | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>cc</sub> | MIN TYP MAX | UNIT |
|-----------------|-----------------|----------------|-----------------|-------------|------|
|                 |                 |                | 2 V             | 246         |      |
| t <sub>pd</sub> | А               | Y              | 4.5 V           | 49          | ns   |
|                 |                 |                | 6 V             | 42          |      |
|                 |                 |                | 2 V             | 298         |      |
| t <sub>en</sub> | ŌĒ              | Y              | 4.5 V           | 60          | ns   |
|                 |                 |                | 6 V             | 51          |      |
|                 |                 |                | 2 V             | 315         |      |
| tt              |                 | Y              | 4.5 V           | 63          | ns   |
|                 |                 |                | 6 V             | 53          |      |

### 6.13 Switching Characteristics, $C_L$ = 150 pF, SN74HC541

<u>over recommended operating free-air temperature range,  $C_L = 150 \text{ pF}$  (unless otherwise noted) (see Figure 7-1)</u>

| PARAMETER       | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>cc</sub> | MIN TYP I | MAX | UNIT |
|-----------------|-----------------|----------------|-----------------|-----------|-----|------|
|                 |                 |                | 2 V             |           | 206 |      |
| t <sub>pd</sub> | А               | Y              | 4.5 V           |           | 41  |      |
|                 |                 |                | 6 V             |           | 35  |      |
|                 |                 |                | 2 V             |           | 250 |      |
| t <sub>en</sub> | ŌĒ              | Y              | 4.5 V           |           | 50  | ns   |
|                 |                 |                | 6 V             |           | 43  |      |
|                 |                 |                | 2 V             |           | 265 |      |
| t <sub>t</sub>  |                 | Y              | 4.5 V           |           | 53  | ns   |
|                 |                 |                | 6 V             |           | 45  |      |

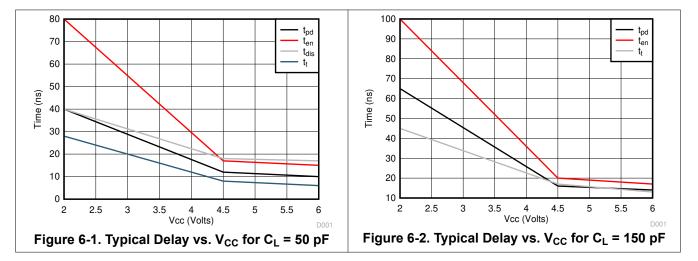
### 6.14 Operating Characteristics

T<sub>A</sub> = 25°C

|                 | PARAMETER                                       | TEST CONDITIONS | TYP | UNIT |
|-----------------|---|-----------------|-----|------|
| C <sub>pd</sub> | Power dissipation capacitance per buffer/driver | No load         | 35  | pF   |



### 6.15 Typical Characteristics



**S2** 

Closed

Open

Closed

Open

Open

Vcc

0 V

≈Vcc

VOL

۷он

≈0 V

**t**PLZ

10%

tPHZ

90%

**S1** 

Open

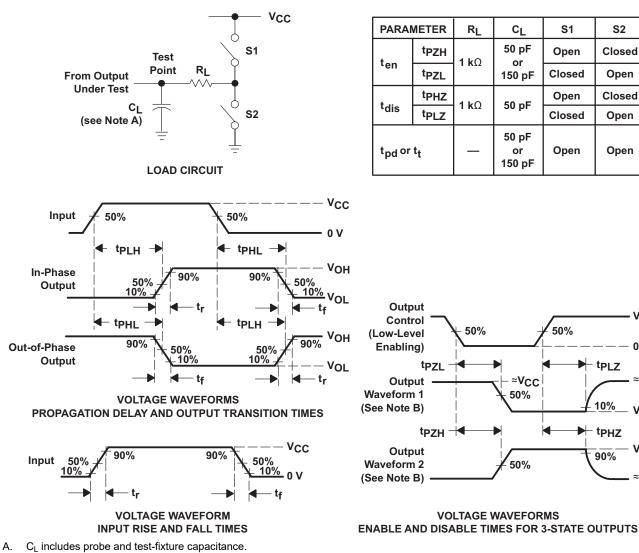
Closed

Open

Closed

Open

50%



7 Parameter Measurement Information

- Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. В Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following C. characteristics: PRR  $\leq$  1 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>r</sub> = 6 ns, t<sub>f</sub> = 6 ns.
- The outputs are measured one at a time with one input transition per measurement. D.
- Ε.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F. t<sub>PZL</sub> and t<sub>PZH</sub> are the same as t<sub>en</sub>.
- t<sub>PLH</sub> and t<sub>PHL</sub> are the same as t<sub>pd</sub>. G.

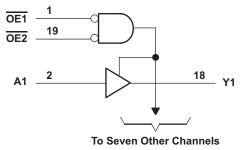
#### Figure 7-1. Load Circuit and Voltage Waveforms

### 8 Detailed Description

### 8.1 Overview

The SN74HC541 device has 8 inputs and outputs where data from the A inputs go to the Y outputs. The output enables of the device control whether the information from the A inputs go to the Y outputs. These enable pins cause the device to go into high Z if either  $\overline{OE1}$  or  $\overline{OE2}$  are high. The  $\overline{OEs}$  should be tied to V<sub>CC</sub> through a pull up resistor to ensure the high impedance state during power up or power down; the minimum value of the resistor is determined by the current sinking capability of the driver.

#### 8.2 Functional Block Diagram



Copyright © 2016, Texas Instruments Incorporated

#### Figure 8-1. Logic Diagram (Positive Logic)

#### 8.3 Feature Description

The SNx4HC541 has a wide operating voltage range of 2 V to 6 V. The device has multiple enable pins, and the device pinout enables simple board layout with outputs across from inputs.

#### 8.4 Device Functional Modes

Table 8-1 lists the functional modes of the SNx4HC541.

|        |                         | •••••••                       |
|--------|-------------------------|-------------------------------|
| INPUTS | OUTPUT                  |                               |
| OE2    | Α                       | Y                             |
| L      | L                       | L                             |
| L      | н                       | н                             |
| Х      | х                       | Hi-Z                          |
| н      | х                       | Hi-Z                          |
|        | INPUTS<br>OE2<br>L<br>L | INPUTS<br>DE2 A<br>L L<br>L H |

#### Table 8-1. Function Table (Each Buffer/Driver)



### 9 Application and Implementation

#### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

#### 9.1 Application Information

SN74HC541 is a wide range CMOS device that can be used over large voltage ranges. The device can be used anywhere from 2 to 6 Volts. The device can drive up to 6 mA of current at 5 Volts. This makes it perfect for driving bus lines directly or up to 15 LSTTL Loads. It can be used to drive anything from micro controllers and system logic devices to LEDs.

#### 9.2 Typical Application

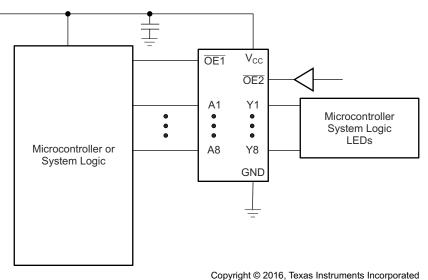


Figure 9-1. Typical Application Diagram

#### 9.2.1 Design Requirements

This device uses CMOS technology and has a wide voltage range. Take care to avoid pulling too much current from the outputs as to not exceed 6 mA. Also, take care to not go over  $V_{CC}$  voltage to avoid damage to the device.

#### 9.2.2 Detailed Design Procedure

- 1. Recommended Input Conditions
  - Rise time and fall time specs: See ( $\Delta t/\Delta V$ ) in the Section 6.3 table.
  - Specified high and low levels: See (VIH and VIL) in the Section 6.3 table.
  - Inputs should not be pulled above V<sub>CC</sub>.
- 2. Recommended Output Conditions
  - Load currents should not exceed 6 mA for the part
  - Outputs should not be pulled above V<sub>CC</sub>.



#### 9.2.3 Application Curve

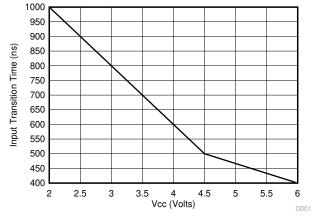


Figure 9-2. Input Transition Time vs. V<sub>CC</sub>



### **10 Power Supply Recommendations**

The power supply can be any voltage between the MIN and MAX supply voltage rating located in the Section 6.3 table.

Each V<sub>CC</sub> pin should have a good bypass capacitor to prevent power disturbance. For devices with a single supply, 0.1- $\mu$ F is recommended; if there are multiple V<sub>CC</sub> pins, then 0.01- $\mu$ F or 0.022- $\mu$ F is recommended for each power pin. It is acceptable to parallel multiple bypass caps to reject different frequencies of noise. A 0.1- $\mu$ F and a 1- $\mu$ F are commonly used in parallel. The bypass capacitor should be installed as close to the power pin as possible for best results.

#### 11 Layout

#### **11.1 Layout Guidelines**

When using multiple bit logic devices inputs should never float.

In many cases, functions or parts of functions of digital logic devices are unused, for example, when only two inputs of a triple-input AND gate are used or only 3 of the 4 buffer gates are used. Such input pins should not be left unconnected because the undefined voltages at the outside connections result in undefined operational states. The Section 6.3 section specifies the rules that must be observed under all circumstances. All unused inputs of digital logic devices must be connected to a high or low bias to prevent them from floating. The logic level that should be applied to any particular unused input depends on the function of the device. Generally they will be tied to GND or  $V_{CC}$  whichever makes more sense or is more convenient. It is generally acceptable to float outputs, unless the part is a transceiver. If the transceiver has an output enable pin, it disables the output section of the part when asserted. This does not disable the input section of the I/Os, so they cannot float when disabled.

#### 11.2 Layout Example

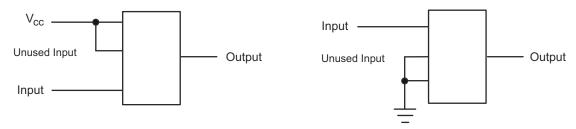


Figure 11-1. Layout Diagram



### 12 Device and Documentation Support

#### 12.1 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

| PARTS     | PRODUCT FOLDER | SAMPLE & BUY | TECHNICAL<br>DOCUMENTS | TOOLS &<br>SOFTWARE | SUPPORT &<br>COMMUNITY |  |
|-----------|----------------|--------------|------------------------|---------------------|------------------------|--|
| SN54HC541 | Click here     | Click here   | Click here             | Click here          | Click here             |  |
| SN74HC541 | Click here     | Click here   | Click here             | Click here          | Click here             |  |

#### Table 12-1. Related Links

#### **12.2 Receiving Notification of Documentation Updates**

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### **12.3 Support Resources**

TI E2E<sup>™</sup> support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

#### 12.4 Trademarks

TI E2E<sup>™</sup> is a trademark of Texas Instruments.

All trademarks are the property of their respective owners.

#### 12.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### 12.6 Glossary

TI Glossary This glossary lists and explains terms, acronyms, and definitions.

#### 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



### **PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)     | Lead finish/<br>Ball material | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|---------------------|-------------------------------|----------------------|--------------|-------------------------|---------|
| JM38510/65711BRA | ACTIVE        | CDIP         | J                  | 20   | 1              | Non-RoHS<br>& Green | SNPB                          | N / A for Pkg Type   | -55 to 125   | JM38510/<br>65711BRA    | Samples |
| M38510/65711BRA  | ACTIVE        | CDIP         | J                  | 20   | 1              | Non-RoHS<br>& Green | SNPB                          | N / A for Pkg Type   | -55 to 125   | JM38510/<br>65711BRA    | Samples |
| SN54HC541J       | ACTIVE        | CDIP         | J                  | 20   | 1              | Non-RoHS<br>& Green | SNPB                          | N / A for Pkg Type   | -55 to 125   | SN54HC541J              | Samples |
| SN74HC541DBR     | ACTIVE        | SSOP         | DB                 | 20   | 2000           | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 85    | HC541                   | Samples |
| SN74HC541DW      | ACTIVE        | SOIC         | DW                 | 20   | 25             | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 85    | HC541                   | Samples |
| SN74HC541DWE4    | ACTIVE        | SOIC         | DW                 | 20   | 25             | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 85    | HC541                   | Samples |
| SN74HC541DWG4    | ACTIVE        | SOIC         | DW                 | 20   | 25             | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 85    | HC541                   | Samples |
| SN74HC541DWR     | ACTIVE        | SOIC         | DW                 | 20   | 2000           | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 85    | HC541                   | Samples |
| SN74HC541N       | ACTIVE        | PDIP         | N                  | 20   | 20             | RoHS & Green        | NIPDAU                        | N / A for Pkg Type   | -40 to 85    | SN74HC541N              | Samples |
| SN74HC541NE4     | ACTIVE        | PDIP         | N                  | 20   | 20             | RoHS & Green        | NIPDAU                        | N / A for Pkg Type   | -40 to 85    | SN74HC541N              | Samples |
| SN74HC541NSR     | ACTIVE        | SO           | NS                 | 20   | 2000           | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 85    | HC541                   | Samples |
| SN74HC541PW      | ACTIVE        | TSSOP        | PW                 | 20   | 70             | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 85    | HC541                   | Samples |
| SN74HC541PWG4    | ACTIVE        | TSSOP        | PW                 | 20   | 70             | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 85    | HC541                   | Samples |
| SN74HC541PWR     | ACTIVE        | TSSOP        | PW                 | 20   | 2000           | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 85    | HC541                   | Samples |
| SN74HC541PWT     | ACTIVE        | TSSOP        | PW                 | 20   | 250            | RoHS & Green        | NIPDAU                        | Level-1-260C-UNLIM   | -40 to 85    | HC541                   | Samples |
| SNJ54HC541FK     | ACTIVE        | LCCC         | FK                 | 20   | 1              | Non-RoHS<br>& Green | SNPB                          | N / A for Pkg Type   | -55 to 125   | SNJ54HC<br>541FK        | Samples |
| SNJ54HC541J      | ACTIVE        | CDIP         | J                  | 20   | 1              | Non-RoHS<br>& Green | SNPB                          | N / A for Pkg Type   | -55 to 125   | SNJ54HC541J             | Samples |

(1) The marketing status values are defined as follows:
 ACTIVE: Product device recommended for new designs.
 LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.



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## PACKAGE OPTION ADDENDUM

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. **PREVIEW:** Device has been announced but is not in production. Samples may or may not be available. **OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### OTHER QUALIFIED VERSIONS OF SN54HC541, SN74HC541 :

• Catalog : SN74HC541

Military : SN54HC541

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product



• Military - QML certified for Military and Defense Applications



Texas

STRUMENTS

### TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal |                 |                    |    |      |                          |                          |            |            |            |            |           |                  |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                      | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| SN74HC541DBR                | SSOP            | DB                 | 20 | 2000 | 330.0                    | 16.4                     | 8.2        | 7.5        | 2.5        | 12.0       | 16.0      | Q1               |
| SN74HC541DBR                | SSOP            | DB                 | 20 | 2000 | 330.0                    | 16.4                     | 8.2        | 7.5        | 2.5        | 12.0       | 16.0      | Q1               |
| SN74HC541DWR                | SOIC            | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.9       | 13.3       | 2.7        | 12.0       | 24.0      | Q1               |
| SN74HC541DWR                | SOIC            | DW                 | 20 | 2000 | 330.0                    | 24.4                     | 10.9       | 13.3       | 2.7        | 12.0       | 24.0      | Q1               |
| SN74HC541NSR                | so              | NS                 | 20 | 2000 | 330.0                    | 24.4                     | 8.4        | 13.0       | 2.5        | 12.0       | 24.0      | Q1               |
| SN74HC541NSR                | so              | NS                 | 20 | 2000 | 330.0                    | 24.4                     | 8.4        | 13.0       | 2.5        | 12.0       | 24.0      | Q1               |
| SN74HC541PWR                | TSSOP           | PW                 | 20 | 2000 | 330.0                    | 16.4                     | 6.95       | 7.0        | 1.4        | 8.0        | 16.0      | Q1               |
| SN74HC541PWR                | TSSOP           | PW                 | 20 | 2000 | 330.0                    | 16.4                     | 6.95       | 7.0        | 1.4        | 8.0        | 16.0      | Q1               |
| SN74HC541PWT                | TSSOP           | PW                 | 20 | 250  | 330.0                    | 16.4                     | 6.95       | 7.1        | 1.6        | 8.0        | 16.0      | Q1               |



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## PACKAGE MATERIALS INFORMATION

28-Sep-2022



| All dimensions are norminal |              |                 |      |      |             |            |             |
|-----------------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| Device                      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
| SN74HC541DBR                | SSOP         | DB              | 20   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74HC541DBR                | SSOP         | DB              | 20   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74HC541DWR                | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74HC541DWR                | SOIC         | DW              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74HC541NSR                | SO           | NS              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74HC541NSR                | SO           | NS              | 20   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74HC541PWR                | TSSOP        | PW              | 20   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74HC541PWR                | TSSOP        | PW              | 20   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74HC541PWT                | TSSOP        | PW              | 20   | 250  | 356.0       | 356.0      | 35.0        |

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### TUBE



## - B - Alignment groove width

#### \*All dimensions are nominal

| Device        | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | Τ (μm) | B (mm) |
|---------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74HC541DW   | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |
| SN74HC541DWE4 | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |
| SN74HC541DWG4 | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |
| SN74HC541N    | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| SN74HC541NE4  | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| SN74HC541PW   | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| SN74HC541PWG4 | PW           | TSSOP        | 20   | 70  | 530    | 10.2   | 3600   | 3.5    |
| SNJ54HC541FK  | FK           | LCCC         | 20   | 1   | 506.98 | 12.06  | 2030   | NA     |

# **DB0020A**



## **PACKAGE OUTLINE**

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-150.



## DB0020A

# **EXAMPLE BOARD LAYOUT**

## SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



## DB0020A

# **EXAMPLE STENCIL DESIGN**

## SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



### MECHANICAL DATA

#### PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



J (R-GDIP-T\*\*) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## FK 20

### 8.89 x 8.89, 1.27 mm pitch

## **GENERIC PACKAGE VIEW**

## LCCC - 2.03 mm max height

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





## N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



## **DW0020A**



## **PACKAGE OUTLINE**

## SOIC - 2.65 mm max height

SOIC



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



## DW0020A

## **EXAMPLE BOARD LAYOUT**

## SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



## DW0020A

## **EXAMPLE STENCIL DESIGN**

## SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



## **PW0020A**



## **PACKAGE OUTLINE**

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



## PW0020A

# **EXAMPLE BOARD LAYOUT**

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



## PW0020A

## **EXAMPLE STENCIL DESIGN**

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



## LAND PATTERN DATA



NOTES: Α. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
  C. Publication IPC-7351 is recommended for alternate design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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